

5	SPECIFICATIONS					
CUSTOMER	:					
SAMPLE CODE	SH800480T0	18-IZB				
MASS PRODUCTION CODE	PH800480T0	PH800480T018-IZB				
SAMPLE VERSION	02	·				
SPECIFICATIONS EDITION	004					
DRAWING NO. (Ver.)	LMD-PH8004	80T018-IZB(Ver:002)				
PACKAGING NO. (Ver.)	PKG- PH8004	480T018-IZB(Ver:001)				
		Deter				
Approved	Checked	Date: Designer				
	Checked	Designer				
Approved 廖志豪 Rex Liao						
廖志豪	Checked 張慶源 Yuan Chang	Designer 陳宗淇				
廖志豪 Rex Liao Preliminary specification fo Specification for sample app	Checked 張慶源 Yuan Chang	Designer 陳宗淇 Howard Chen				
廖志豪 Rex Liao Preliminary specification fo Specification for sample app	Checked 張慶源 Yuan Chang or design input proval WERTIP TECH. CORP	Designer 陳宗淇 Howard Chen				



# **History of Version**

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
04/07/2015	01	001	New Sample	-	Howard
08/17/2015	01	002	Add Lifetime	9	Howard
10/02/2015	02	003	Second Sample Modify DC Electrical Characteristics Modify FPC terminal shape & Tolerance	5 Appendix	Howard
12/10/2015	02	004	Modify Interface Pin Description Add latching data at the rising edge	16	Howard
				То	tal: 30 Pages



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Note : For detailed information please refer to IC data sheet :

Primacy(TFT LCD): ORISETECH: OTA7001A\_C/OTD9960A

(Or compatible IC )



# **1. SPECIFICATIONS**

## 1.1 Features

Item	Standard Value			
Display Type	800 * 3 (RGB) * 480 Dots			
LCD Type	a-Si TFT , Normally white, Transmissive type			
Screen size(inch)	5.0 inch			
Viewing Direction	6 O'clock			
Color configuration	RGB-Strip			
Backlight Type	LED B/L			
Interface	Digital 24-bits RGB			
Other(controller/driver IC)	Soruce IC :OTA7001A_C/ Gate IC: OTD9960A (Or Compatible IC )			
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer website :			
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/			

# 1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	121.0(W) x 75.9 (L) x 4.2(H)	mm

#### LCD panel

Item	Standard Value	Unit
Viewing Area	109.0 (W) * 65.8 (L)	mm
Active Area	108.0 (W) x 64.8 (L)	mm
Pixel Size	0.135 (W) * 0.135 (H)	mm

Touch panel

Item	Standard Value	Unit
Viewing Area	110.4 (W) * 67.4 (L)	mm
Active Area	109.0 (W) * 65.8 (L)	mm

Note : For detailed information please refer to LCM drawing



# **1.3 Absolute Maximum Ratings**

#### Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDD	GND=0	-0.3	4.5	V
Operating Temperature	T <sub>OP</sub>	-	-20	70	°C
Storage Temperature	T <sub>ST</sub>	-	-30	80	°C

## **1.4 DC Electrical Characteristics**

Module				GN	D = 0V, Ta :	= 25°C
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	VDD		3.0	3.3	3.6	V
	VIH	-	0.7VDD	-	VDD	V
Input H/L Level Voltage	VIL	-	GND	-	0.3VDD	V
Output H/L Level	VOH	-	VDD-0.4	-	VDD	V
Voltage	VOL	-	GND	-	GND+0.4	V
Supply Current		VDD= 3.3 V Pattern=Picture	_	60	-	mA
Supply Current	I <sub>DD</sub>	VDD= 3.3 V Pattern=Black *1		70	110	mA

Note1:Maximum current display



# **1.5 Optical Characteristics**

## TFT LCD Module

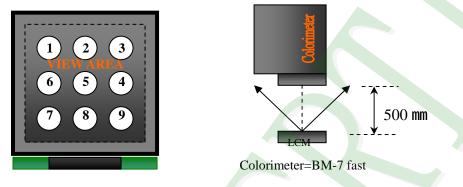
VDD= 3.3 V, Ta=25°C

							5.0 V, I		
Item		Symbol	Condition	Min.	Тур.	Max.	unit	-	
Response time	Tr+Tf	25	-	-	24	36	ms	-	
	Тор	θY+		-	60				
	Bottom	θY-	CR ≥ 10	-	60	-	Dog	Noto 4	
Viewing angle	Left	θХ-	CR ≥ 10	-	60	-	Deg.	Note 4	
	Right	θX+		-	60	-			
Contrast rati	0	CR		500	600	-	1	Note 3	
	\//bito	Х		0.26	0.31	0.36			
	White	Y		0.26	0.31	0.36			
	Dod	Х	Ta = 25°C	0.58	0.63	0.68			
Color of CIE Coordinate	Red	Reu	Y	$\theta X, \theta Y = 0^{\circ}$	0.30	0.35	0.40		Note1
(With B/L & T/P)	Croop	Х	$\Theta X$ , $\Theta Y = 0^{-1}$	0.31	0.36	0.41	-	noter	
	Green	Y		0.54	0.59	0.64			
	Dhue	Х		0.10	0.15	0.20			
	Blue	Y		0.05	0.10	0.15			
Average Brightr	ness								
Pattern=white di	splay	IV	IF= 40 mA	220	340	-	cd/m2	Note1	
(With B/L & T/F	P)*1								
Uniformity (With B/L & T/F	P)*2	В	IF= 40 mA	70	-	-	%	Note1	



Note 1:

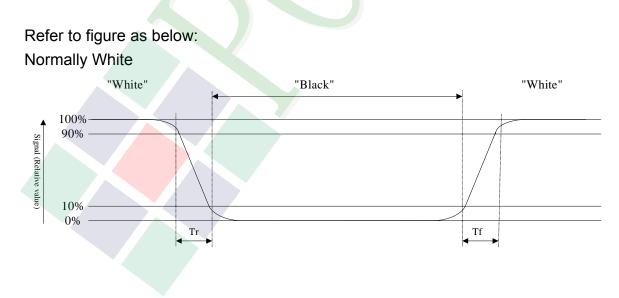
- \*1 : B=B(min) / B(max) \* 100%
- \*2 : Measurement Condition for Optical Characteristics:
  - a : Environment: 25 ±5 / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
  - b : Measurement Distance: 500  $\pm$  50 mm  $\,$  , (0= 0°)
  - c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.
  - d : The uncertainty of the C.I.E coordinate measurement ±0.01 , Average Brightness ± 4%



To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

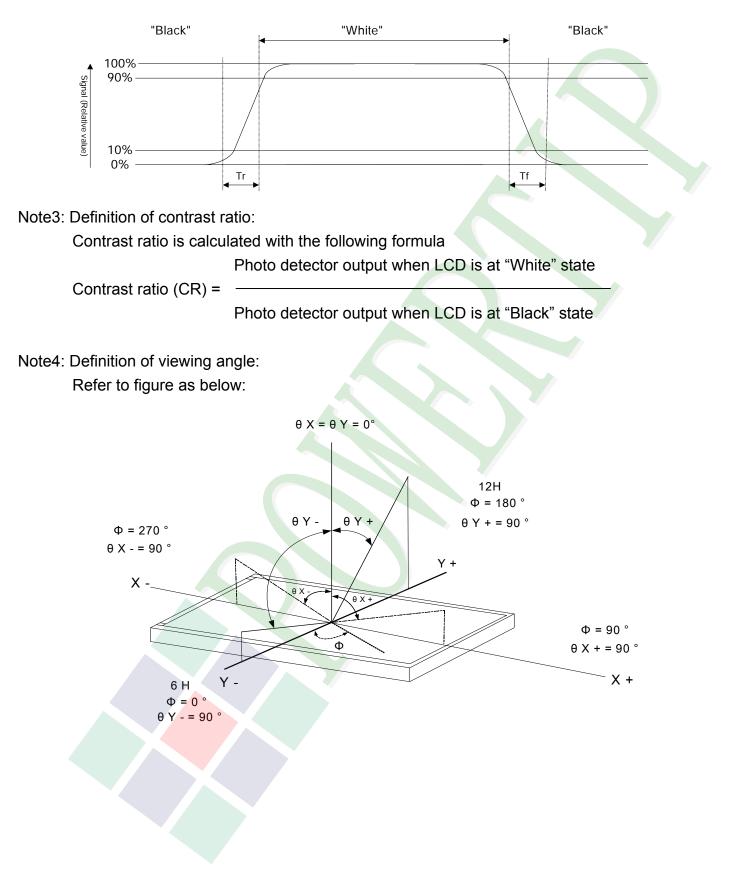
Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black"(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.





Normally Black





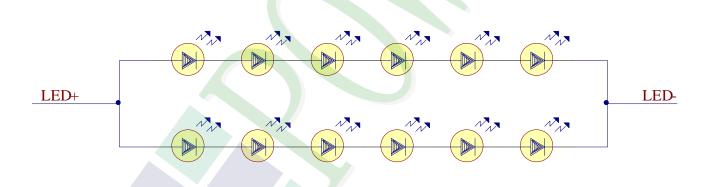
## **1.6 Backlight Characteristics**

#### Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current	IF	Ta =25	-	100	mA
LED Reverse Current	IR	Ta =25	-	50	uA
Power Dissipation	PD	Ta =25	-	768	mW

#### Electrical / Optical Characteristics

Elecated a parear charact						
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		18.6	19.2	-	V
Average Brightness (Without LCD &T/P)	IV	IF=40mA	9500	10900	<b>Y</b> -	cd/m <sup>2</sup>
CIE Color Coordinate	X		-	0.28	-	
(Without LCD &T/P)	Y		-	0.28	-	_
Color			White			
Lifetime		2000	Ohrs at 2	.5		





# 1.7 Touch Panel Specification

#### 1.7.1 Optical Characteristics

Item	Specification
1.Transparency	78% Min

#### 1.7.2 Mechanical Characteristic

Item	Specification
1.Input Method	Finger or stylus pen
2.Hardness of surface	3H -pressure 500g of ,45deg.
3.Activation Force	120gf less individual point with stylus pen(R0.8)
	Activation force guarantee area:3.0mm inside of Active Area.
4.Linearity Force	120gf less input with stylus pen(R0.8)
	Activation force guarantee area:3.0mm inside of Active Area.

#### 1.7.3 Electrical Characteristics

Specification
DC 5V(DC 7V Max)
Direction X (Film side): $200\Omega \sim 1050\Omega$
Direction Y (Glass side): $100\Omega \sim 900\Omega$
20 MΩ or more (DC 25 1min)
±1.5%.
Linearity(%)= $\Delta V/$ (EV-SV) *100.
$\Delta V$ : The difference between the ideal voltage and measured voltage on the each measuring line.
SV: Voltage of starting Points.
EV: Voltage of Ending Points.
(Test condition refers to 1.7.2 item4)
<10ms (Tip R 3.75mm, hardness 10°~20°, silicon rubber, 500gf
operation : 40 mm/sec )

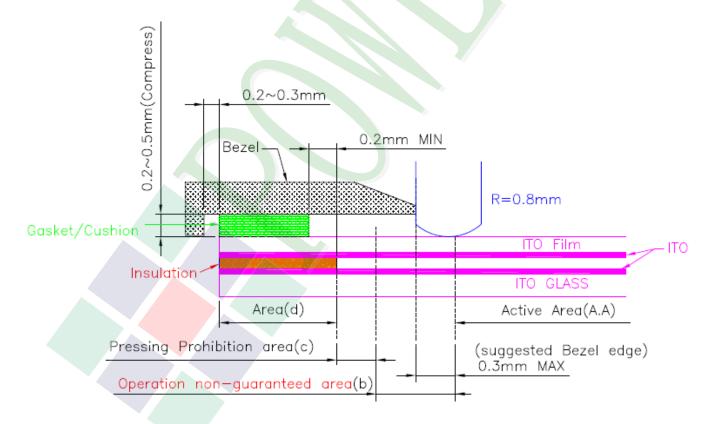


## 1.7.4 Reliability Characteristic

NO	Test Item	Test Condition	Test Result
	Hitting Durability	1,000,000times min.(R 8 mm	Follow 1.7.3 item2 and
1		Silicon Rubber Hardness	item4.
		60°250gf 3times/sec).	
2	Pen Sliding Durability	100,000 times min	Follow 1.7.3 item2 and
2		(TipR0.8mm).	item4.
		ψ9mm steel ball is dropped on	No Crack
3	Impact Resistance	the surface from 30 cm height	
		at 1 time.	
4	Flexible pattern Bending	Bending 3 times by bending	Follow 1.7.3 item2.
4	Resistance	radius R1.0 mm	



- 1.7.5 Touch Panel Design/Handing Guide
- (1) Keep the gap, for example 0.2 to 0.3mm, between bezel edge and T/P edge.
   The reason is to avoid the bezel edge from contacting T/P surface that may cause "short" with bottom layer
- (2) Insertion a cushion material is recommended.
- (3) The cushion material should be limited on the busbar insulation paste area. If it is over the transparent insulation paste area, a "short" may be occurred.
- (4) Do not to use an adhesive tape to bond it on the front of T/P and hang it to the housing bezel.
- (5) Never expand the T/P top layer (PET Film) like a balloon by internal air pressure. The life of the T/P will extremely decreasing.
- (6) Top layer, PET, dimension is changing base on environment temperature and humidity. Please avoid a stress from housing bezel to top layer, because it may cause "waving".
- (7) The input to the Touch Panel sometimes distorts touch panel itself.
- (8)To use the stylus pen or fingernail sliding at the edge of the housing is prohibited. It would cause the cracking of the ITO coating and damage the touch panel. It also request not to press this area while assembling
- (9) Purpose: In order to prevent accidental use and performance deterioration, please keep the following precautions.



In order to prevent unusual performance degradation and malfunction of a touch panel, please carry out the set case designing and a touch panel assembling method after surely considering the definition of each area illustrated in above figure.



#### Area(a) : Active area

The active area is guaranteed the position data detectable precision, operation force and other operations. it is strongly recommended to place the operation button or menu keys within the active area. Due to structure, the active area is less durable at the edge or close to the edge.

#### Area(b) : Operation non-guaranteed area

This area does not guarantee a touch panel operation and its function. When this area is pressed, touch panel shows degradation of its performance and durability such as a pen sliding durability becomes about one-tenth compared with the active area (area-(a) as guaranteed area) and its operation force requires about double. About 0.5 mm outside from a boundary of the active area corresponds to this area.

#### Area(c) : Pressing prohibition area

The area which forbids pressing, because an excessive load is applied to a transparent electrode (ITO) and a serious damage is given to a touch panel function by pressing. About 0.5 mm outside from Operation non-guaranteed area .

Area(d) : Non-Active area The area does not activate even if pressed.



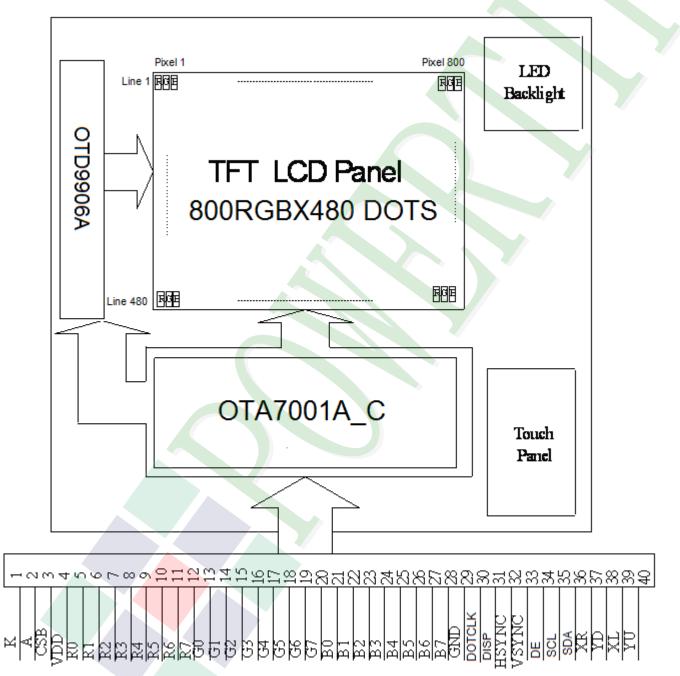
# 2. MODULE STRUCTURE

## 2.1 Counter Drawing

#### 2.1.1 LCM Mechanical Diagram

\* See Appendix

#### 2.1.2 Block Diagram



**POWERTIP** 

# 2.2 Interface Pin Description

Pin No.	Symbol	Function
1	LED-	Power supply for LED Backlight cathode input
2	LED+	Power supply for LED Backlight anode input
3	CS(NC)	Chip select pin of serial interface.
4	VDD	Digital power
5	R0	Red data bit 0
6	R1	Red data bit 1
7	R2	Red data bit 2
8	R3	Red data bit 3
9	R4	Red data bit 4
10	R5	Red data bit 5
11	R6	Red data bit 6
12	R7	Red data bit 7
13	G0	Green data bit 0
14	G1	Green data bit 1
15	G2	Green data bit 2
16	G3	Green data bit 3
17	G4	Green data bit 4
18	G5	Green data bit 5
19	G6	Green data bit 6
20	G7	Green data bit 7

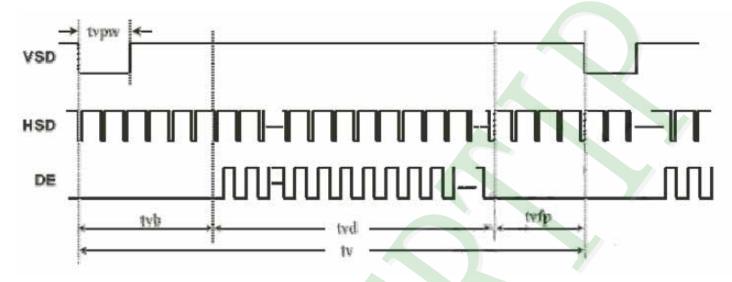


Pin No.	Symbol	Function
21	B0	Blue data bit 0
22	B1	Blue data bit 1
23	B2	Blue data bit 2
24	B3	Blue data bit 3
25	B4	Blue data bit 4
26	B5	Blue data bit 5
27	B6	Blue data bit 6
28	B7	Blue data bit 7
29	GND	Ground
30	DOTCLK	Dot data clock, latching data at the rising edge
31	DISP	Display on/ off
32	HSYNC	Horizontal sync input
33	VSYNC	Vertical sync input
34	DE	Data enable
35	SCL(NC)	Data input and output in Serial communication/No connection when no using serial communication
36	SDA(NC)	Clock input in Serial communication / No connection when no using serial communication
37	XR	TP: X right
38	YD	TP: Y bottom
39	XL	TP: X left
40	YU	TP: Y top



## 2.3 Timing Characteristics

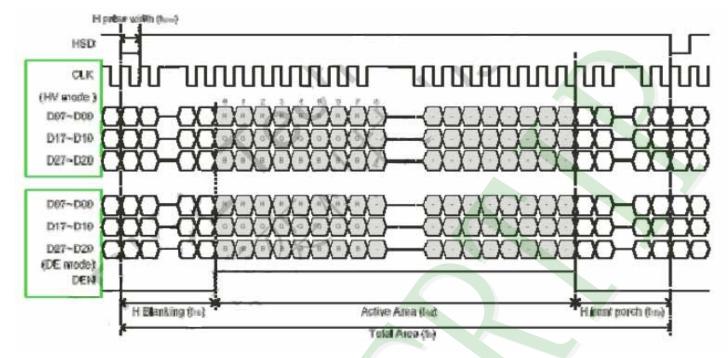
## 2.3.1 Vertical input timing



Parameter	Value		Unit
Falametei	Symbol	Min Typ Max	Unit
Vertical display area	tvd	480	Н
VSD period time	tv	525	Н
VSD pulse width	tvpw	3	Н
VSD Back	tvb	32	Н
Porch(Blanking)	LVD	52	
VSD Front Proch	tvfb	13	Н



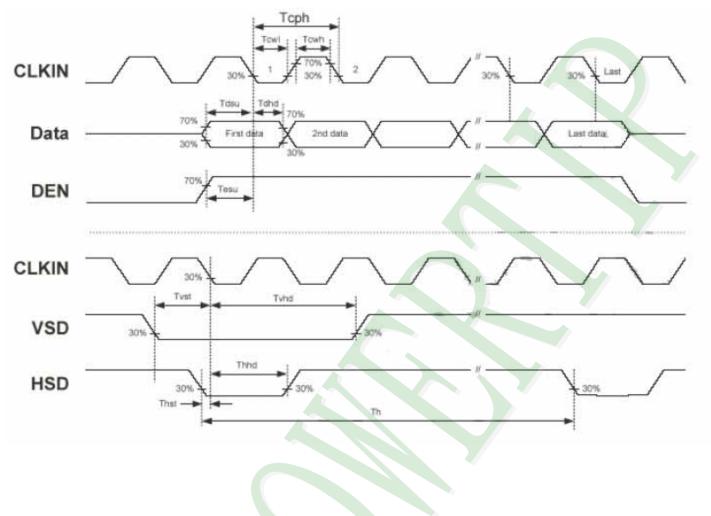
2.3.2 Horizontal input timing



Parameter		Symb		Value		Unit
Falameter		ol	Min	Тур	Max	Offic
Horizontal display	y area	thd		800		DCLK
DCLK frequer	су	fclk	-	30	50	MHz
1 Horizontal L	ine	th		928		
	Min			1		
HSD pulse width	Тур	thpw		48		
Width	Max			-		DCLK
HSD Back Pol (Blacking)	rch	thp	-	88	-	
HSD Front Pro	och	thfb	-	40	-	



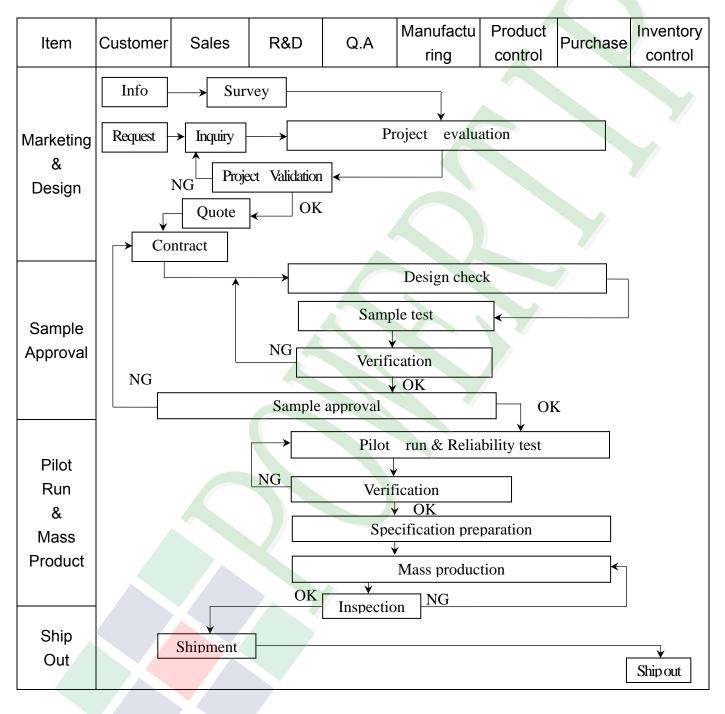
## 2.3.2 Input Clock and Data Timing





# **3. QUALITY ASSURANCE SYSTEM**

# 3.1 Quality Assurance Flow Chart



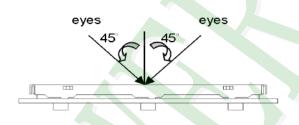


Item	Customer	Sales	R&D	Q.A	Manufact uring	Product control	Purchase	Inventory control
Sales Service	Info	→ Claim sis report	[	Trackin	Failure an Corrective			
Q.A Activity	1. ISO 900 3. Equipme 5. Standard		ion	4	Process in . Education	•		es

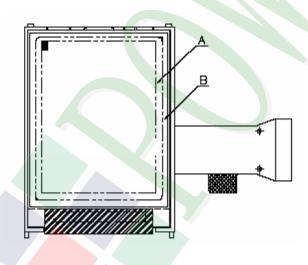
# **POWERTIP**

#### 3.2 Inspection Specification

- ◆Scope: The document shall be applied to TFT-LCD Module for 3. 5″~10″ (Ver.B01).
- ◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge、MIL-STD、Powertip Tester、Sample
- ◆Defect Level : Major Defect AQL : 0.4 ; Minor Defect AQL : 1.5
- ♦OUT Going Defect Level : Sampling.
- ◆Standard of the product appearance test :
  - a. Manner of appearance test :
  - (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
  - (2). The test direction is base on about around  $45^{\circ}$  of vertical line.



(3). **Definition** of area.



- A area : viewing area
- **B** area : Outside of viewing area

(4). Standard of inspection : (Unit : mm)



#### ◆Specification For TFT-LCD Module 3. 5″~10″:

NO	Item	Criterion	Level
	Item	1. 1The part number is inconsistent with work order of production.	Major
01	01 Product condition	1. 2 Mixed product types.	Major
		1. 3 Assembled in inverse direction.	Major
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to structure diagram.	Major
		4. 1 Missing line character and icon.	Major
04	Electrical Testing	4. 2 No function or no display.	
		4. 3 Display malfunction.	
		4.4 LCD viewing angle defect.	Major
		4. 5 Current consumption exceeds product specifications.	Major
		Item Acceptance (Q'ty)	
	Dot defect	Bright Dot $\leq 4$	
	Dot defect	Dot Dark Dot ≦ 5	
	(Bright dot 、	Defect Joint Dot $\leq 3$	
05 Dark dot) On -display	Dark dot)	Total $\leq 7$	Minor
	<ul> <li>5.1 Inspection pattern : full white , full black , Red , Green and blue screens.</li> <li>5. 2 It is defined as dot defect if defect area &gt;1/2 dot.</li> <li>5. 3 The distance between two dot defect ≥5 mm.</li> </ul>		



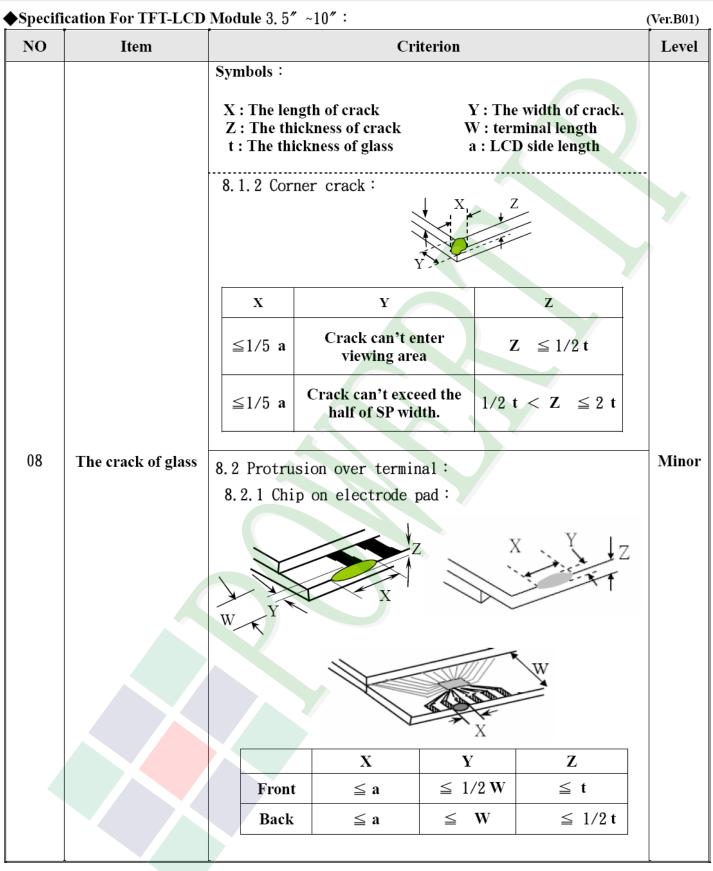
♦Speci	fication For TFT-L	CD Module 3. 5″~10″:	(Ver.B01)				
NO	Item	Criterion					
		6. 1 Round type ( Non-display or display) :					
		Dimension (diameter : Φ)     Acceptance (Q'ty)       A area     B area					
	Black or white dot 、 scratch 、	$\Phi \leq 0.25$ Ignore					
	contamination	$0.25 < \Phi \leq 0.50 \qquad 5 \qquad \text{Ignore}$					
	Round type → <sub>X</sub> ←	$\Phi > 0.50$ 0					
00	Y T T T	Total 5					
06	$\Phi = (x+y)/2$	6. 2 Line type( Non-display or display) :	Minor				
	Line type	Length (L) Width (W) A area B area					
		$ W \le 0.03 \qquad \text{Ignore}$					
		$L \le 10.0$ 0.03 < $W \le 0.05$ 4					
		L $\leq 5.0$ 0.05 < W $\leq 0.10$ 2 Ignore					
		W >0.10 As round type					
		Total 5					
		Accentance (O2tri)					
		Dimension (diameter : Φ)         Acceptance (Q'ty)           A area         B area					
		$\Phi \leq 0.25$ Ignore					
07	Polarizer	$0.25 < \Phi \leq 0.50$ 4	Minor				
	Bubble	$0.50 < \Phi \leq 0.80$ 1 Ignore					
		$\Phi > 0.80$ 0					
		Total 5					



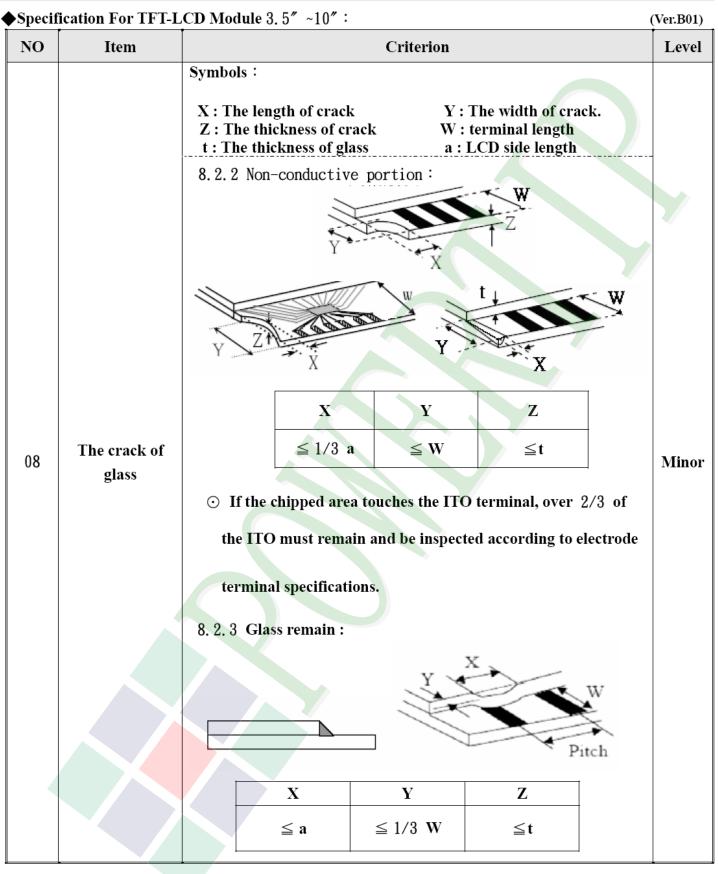
#### ◆Specification For TFT-LCD Module 3.5″~10″:

NO	Item	Criterion		Level
		Symbols : X : The length of crack Z : The thickness of crack	Y : The width of crack. W : terminal length a : LCD side length	
		8.1 General glass chip: 8.1.1 Chip on panel surface and cra	ack between panels:	
		y X Z	Z Y Y	
08	The crack of glass	SP	SP [NG]	Minor
		[OK] X Seal width	Y	
		Z.		
		X Y ≤ a Crack can't enter viewing area	$z \le 1/2 t$	
		≤ a Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$	











#### ◆ Specification For TFT-LCD Module 3. 5″~10″:

Specification For TFT-LCD Module 3. 5" ~10" : (V					
NO	Item	Criterion	Level		
		9. 1 Backlight can't work normally.	Major		
09	Backlight elements	9. 2 Backlight doesn't light or color is wrong.	Major		
		9. 3 Illumination source flickers when lit.	Major		
	General appearance	10. 1 Pin type < quantity < dimension must match type in structure diagram.	Major		
		10. 2 No short circuits in components on PCB or FPC .	Major		
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major		
10		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor		
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor		
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC ) is ≤1.5 mm.	Minor		



# 4. RELIABILITY TEST

## 4.1 Reliability Test Condition

(Ver.B01)

7.1	Reliability lest co	
NO.	TEST ITEM	TEST CONDITION
1	High Temperature Storage Test	Keep in +80 ±296 hrsSurrounding temperature, then storage at normal condition 4hrs.
2	Low Temperature Storage Test	Keep in -30 ±2 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
3	High Temperature / High Humidity Storage Test	Keep in +60/ 90% R.H duration for 96 hrsSurrounding temperature, then storage at normal condition 4hrs.(Excluding the polarizer)
4	Temperature Cycling Storage Test	-30 +25 +80 +25 (30mins) (5mins) (30mins) (5mins) ↓ 10 Cycle Surrounding temperature, then storage at normal condition 4hrs.
5	ESD Test	Air Discharge:Contact Discharge:Apply 2 KV with 5 timesApply 250 V with 5 timesDischarge for each polarity +/-discharge for each polarity +/-1. Temperature ambiance : 15352. Humidity relative : 30% 60%3. Energy Storage Capacitance(Cs+Cd) : 150pF±10%4. Discharge Resistance(Rd) : 330 ±10%5. Discharge, mode of operation :Single Discharge (time between successive discharges at least 1 sec)(Tolerance if the output voltage indication : ±5%)
6	Vibration Test (Packaged)	<ol> <li>Sine wave 10 55 Hz frequency (1 min/sweep)</li> <li>The amplitude of vibration :1.5 mm</li> <li>Each direction (X, Y, Z) duration for 2 Hrs</li> </ol>
7	Drop Test (Packaged)	Packing Weight (Kg)         Drop Height (cm)           0 ~ 45.4         122           45.4 ~ 90.8         76           90.8 ~ 454         61           Over 454         46   Drop Direction : 1 corner / 3 edges / 6 sides each 1 time
		Drop Drection . Teorner / o cuges / o sides cach tunic



# **5. PRECAUTION RELATING PRODUCT HANDLING**

## 5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

## **5.2 HANDLING**

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10 and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .

## 5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25 \pm 5$  and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

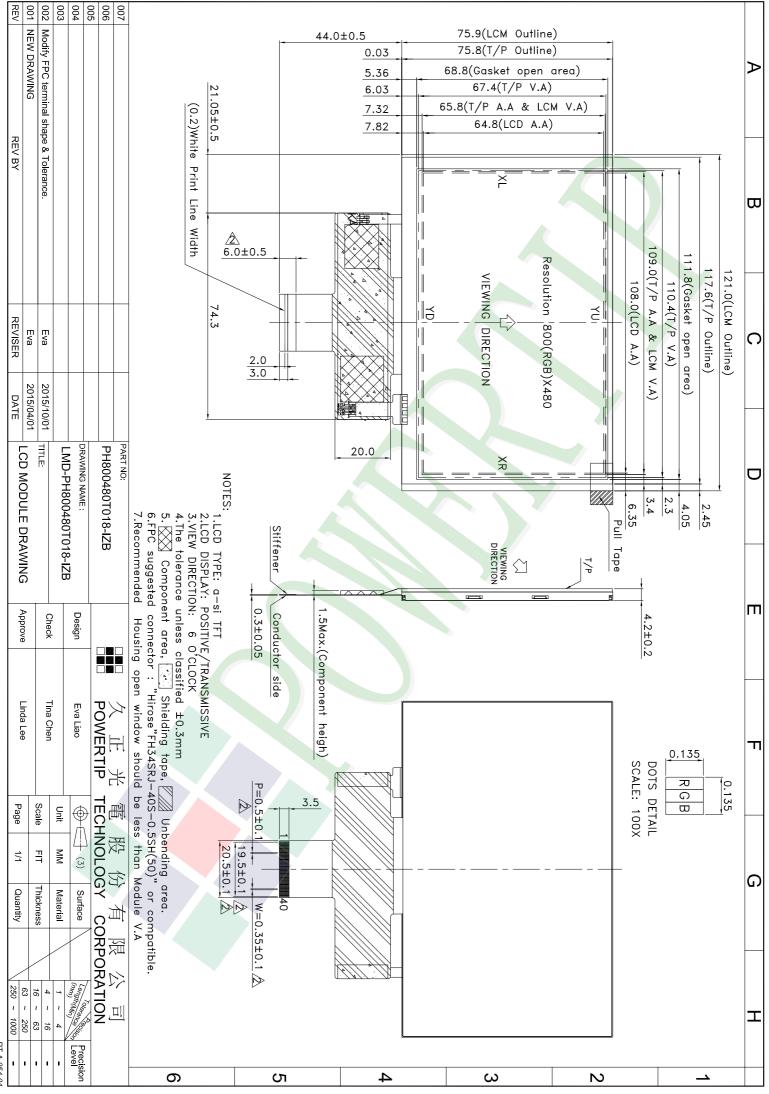
## **5.4 TERMS OF WARRANTY**

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



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